Inductors for power circuits
Thin-film metal magnetic material
TFM-BLF series

RoHS REACH Halogen Free Lead Free

TFM201208BLF type

Product Portal Search Simulation Model Selection Guide Tech Library Tech Note Application Guides

FEATURES

- By using metal magnetic material with high Saturation magnetic flux density the excellent DC bias characteristics needed for inductors for power circuits can be achieved.
- With the same product shape and terminal structure as general chip parts it has excellent mounting stability characteristics and can also be mounted to general-purpose land patterns.
- By using a closed magnetic circuit structure leakage flux is minimized.

APPLICATION

- Smart phones, smart watch, tablet terminals, HDD, SSD, mobile display panels, portable game devices, compact power supply modules, TWS, AR/VR, other

PART NUMBER CONSTRUCTION

TFM	201208	BLF	-	1R0	M	T	CA
Series name	L×W×H dimensions 2.0×1.20×0.8 mm	Characteristic type		Inductance (µH)	Inductance tolerance	Packaging style	Internal code

CHARACTERISTICS SPECIFICATION TABLE

L		L Measuring frequency	DC resistance		Rated current*				Part No.
					Isat		Itemp		
(µH)	Tolerance	(MHz)	(mΩ)max.	(mΩ)typ.	(A)max.	(A)typ.	(A)max.	(A)typ.	
1.0	±20%	1	55	50	3.4	3.7	2.7	2.9	TFM201208BLF-1R0MTCA

* Rated current: smaller value of either Isat or Itemp.
Isat: When based on the inductance change rate (30% decrease from the lower limit of the L standard)
Itemp: When based on the temperature increase (temperature increase of 40°C by self heating)

Measurement equipment

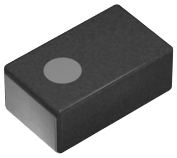
Measurement item	Product No. *	Manufacturer
L	4294A	Keysight Technologies
DC resistance	AX-114N	ADEX
Rated current Isat	4285A+42841A+42842C	Keysight Technologies

* Equivalent measurement equipment may be used.

TEMPERATURE RANGE, INDIVIDUAL WEIGHT

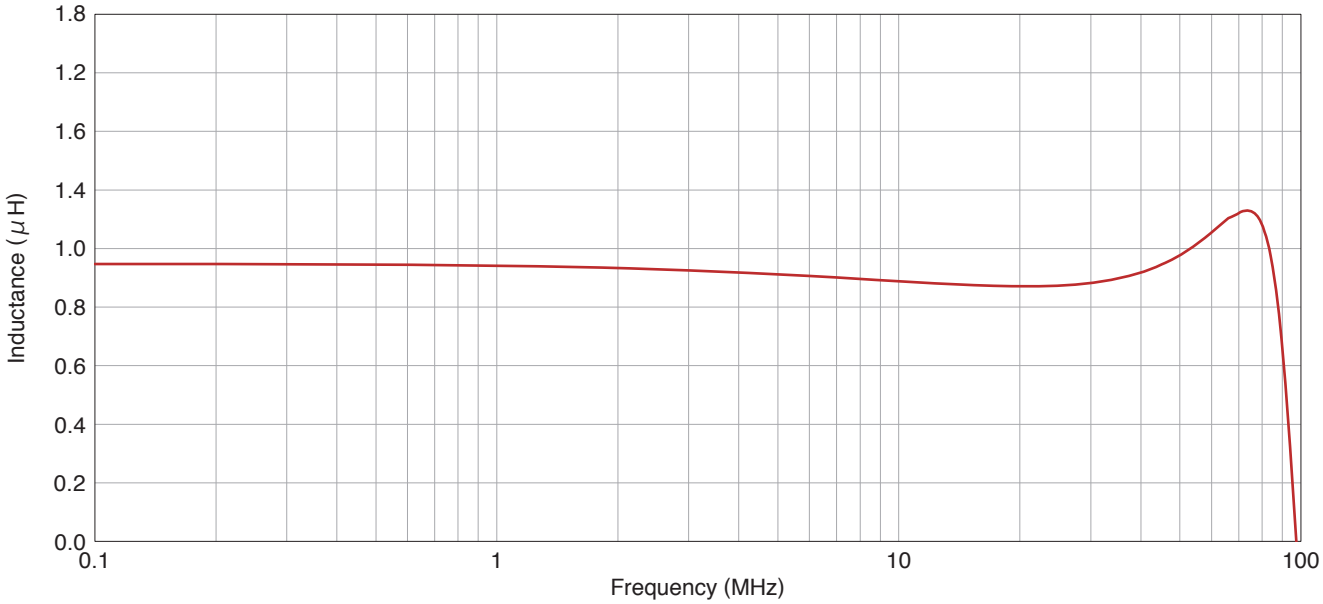
Operating temperature range *	Storage temperature range **	Individual weight
-40 to +125 °C	-40 to +125 °C	0.011 g

* Operating temperature range includes self-heating.
** The storage temperature range is for after the assembly.



TFM201208BLF type

L FREQUENCY CHARACTERISTICS

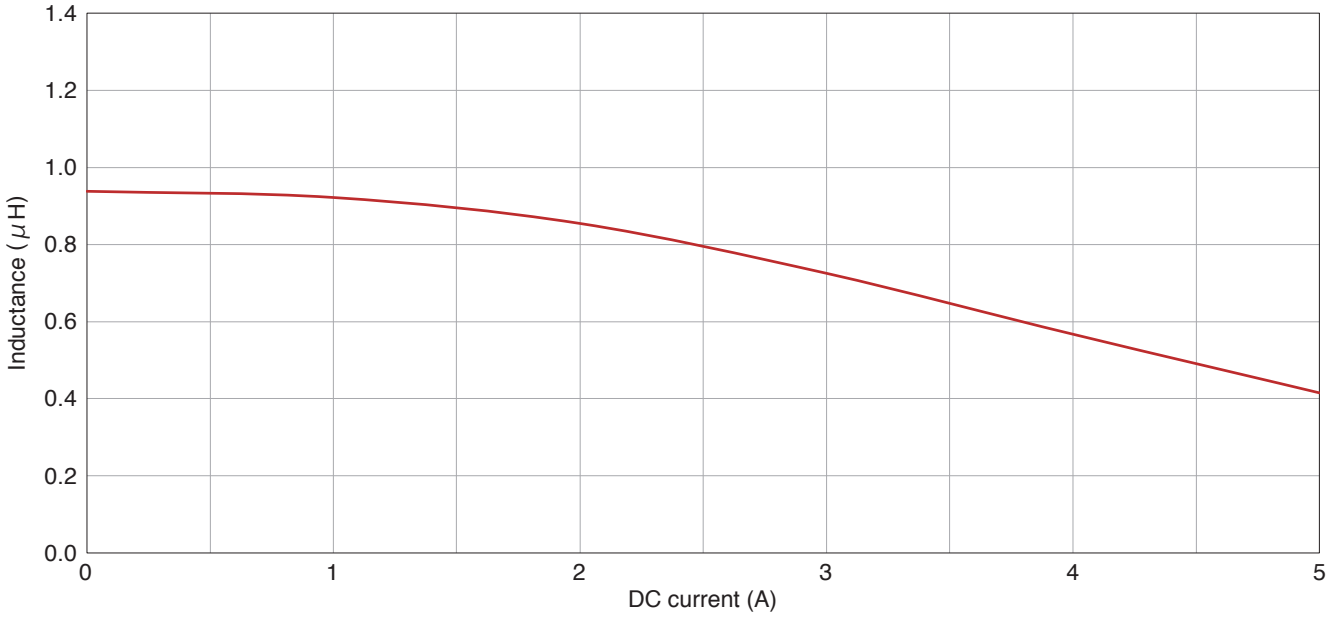


Measurement equipment

Product No. *	Manufacturer
4294A	Keysight Technologies

* Equivalent measurement equipment may be used.

INDUCTANCE VS. DC BIAS CHARACTERISTICS



Measurement equipment

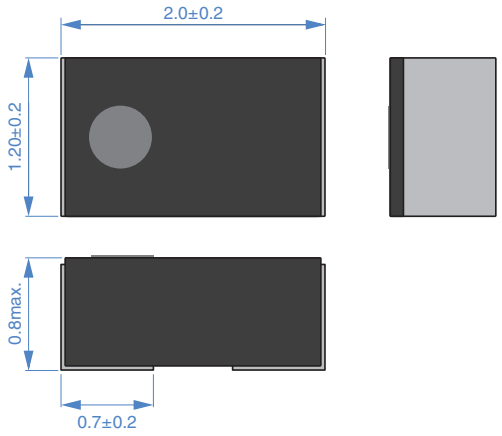
Product No. *	Manufacturer
4285A+42841A+42842C	Keysight Technologies

* Equivalent measurement equipment may be used.

⚠ Please be sure to request delivery specifications that provide further details on the features and specifications of the products for proper and safe use.
Please note that the contents may change without any prior notice due to reasons such as upgrading.

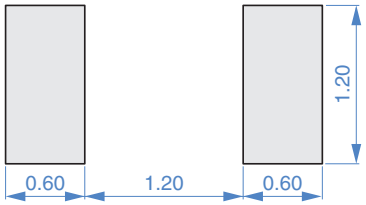
TFM201208BLF type

SHAPE & DIMENSIONS



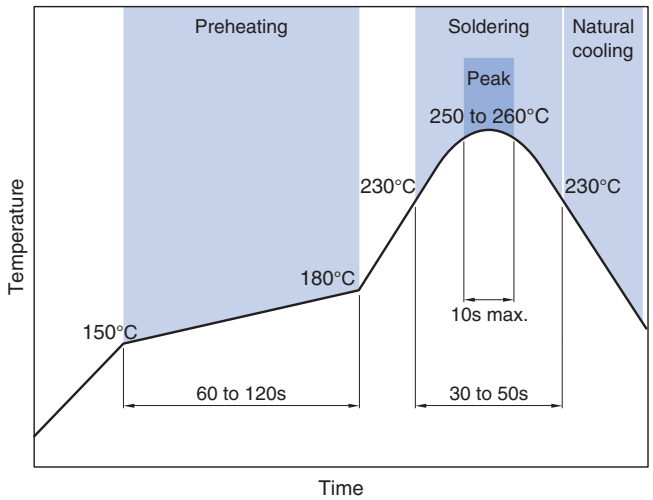
Dimensions in mm

RECOMMENDED LAND PATTERN



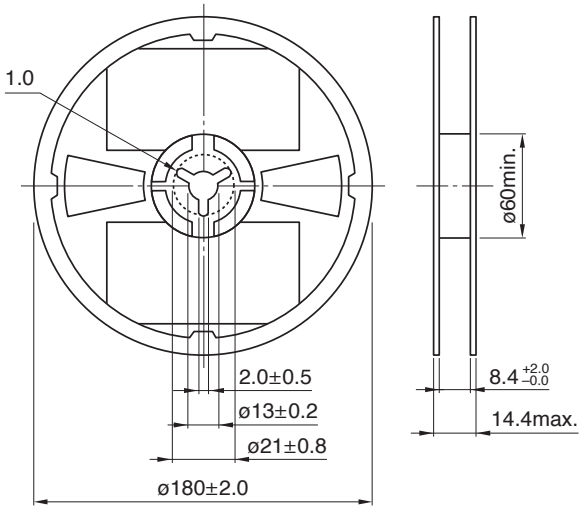
Dimensions in mm

RECOMMENDED REFLOW PROFILE



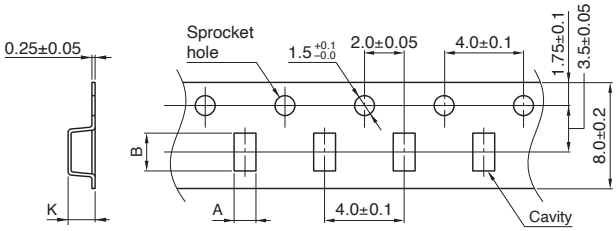
PACKAGING STYLE

REEL DIMENSIONS



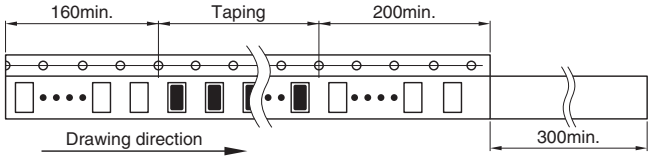
Dimensions in mm

TAPE DIMENSIONS



Dimensions in mm

Type	A	B	K
TFM201208BLF	1.55	2.35	1.1



Dimensions in mm

PACKAGE QUANTITY

Package quantity	3000 pcs/reel

REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using this products

REMINDERS

- The storage period is within 6 months. Be sure to follow the storage conditions (temperature: 5 to 40°C, humidity: 20 to 75% RH or less).
  If the storage period elapses, the soldering of the terminal electrodes may deteriorate.
- Do not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.).
- Soldering corrections after mounting should be within the range of the conditions determined in the specifications.
  If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
- When embedding a printed circuit board where a chip is mounted to a set, be sure that residual stress is not given to the chip due to the overall distortion of the printed circuit board and partial distortion such as at screw tightening portions.
- Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.
- Carefully lay out the coil for the circuit board design of the non-magnetic shield type.
  A malfunction may occur due to magnetic interference.
- Use a wrist band to discharge static electricity in your body through the grounding wire.
- Do not expose the products to magnets or magnetic fields.
- Do not use for a purpose outside of the contents regulated in the delivery specifications.
- The products listed on this catalog are intended for use in general electronic equipment (AV equipment, telecommunications equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment, industrial robots) under a normal operation and use condition.
  The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property.
  If you intend to use the products in the applications listed below or if you have special requirements exceeding the range or conditions set forth in the each catalog, please contact us.

(1) Aerospace/aviation equipment
(2) Transportation equipment (cars, electric trains, ships, etc.)
(3) Medical equipment
(4) Power-generation control equipment
(5) Atomic energy-related equipment
(6) Seabed equipment
(7) Transportation control equipment
(8) Public information-processing equipment
(9) Military equipment
(10) Electric heating apparatus, burning equipment
(11) Disaster prevention/crime prevention equipment
(12) Safety equipment
(13) Other applications that are not considered general-purpose applications

When designing your equipment even for general-purpose applications, you are kindly requested to take into consideration securing protection circuit/device or providing backup circuits in your equipment.